



PRODUCT/PROCESS CHANGE NOTIFICATION

PCN APM-IPC/07/2923
Notification Date 09/25/2007

**L6726A/TR, L6727/TR, L6783A/TR Devices in SO8 package -
2nd source of Assembly & testing plant in Bouskoura 2000 plant**

IPC - IND.& POWER CONV.

Table 1. Change Identification

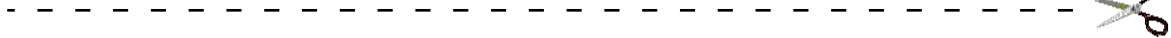
Product Identification (Product Family/Commercial Product)	L6726A/TR, L6727/TR, L6783A/TR Devices
Type of change	Package assembly location change
Reason for change	Company roadmap & capacity increase
Description of the change	SOIC NARROW ASSEMBLY & TESTING 2nd SOURCE IN ST BOUSKOURA 2000
Product Line(s) and/or Part Number(s)	See attached
Description of the Qualification Plan	See attached
Change Product Identification	"Z" as second digit of the traceability code
Manufacturing Location(s)	

Table 2. Change Implementation Schedule

Forecasted implementation date for change	01-Oct-2007
Forecasted availability date of samples for customer	20-Nov-2007
Forecasted date for STMicroelectronics change Qualification Plan results availability	02-Dec-2007
Estimated date of changed product first shipment	31-Dec-2007

Table 3. List of Attachments

Customer Part numbers list	
Qualification Plan results	



Customer Acknowledgement of Receipt		PCN APM-IPC/07/2923					
Please sign and return to STMicroelectronics Sales Office		Notification Date 09/25/2007					
<input type="checkbox"/> Qualification Plan Denied <input type="checkbox"/> Qualification Plan Approved <input type="checkbox"/> Change Denied <input type="checkbox"/> Change Approved	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr><td style="padding: 2px;">Name:</td></tr> <tr><td style="padding: 2px;">Title:</td></tr> <tr><td style="padding: 2px;">Company:</td></tr> <tr><td style="padding: 2px;">Date:</td></tr> <tr><td style="padding: 2px;">Signature:</td></tr> </table>		Name:	Title:	Company:	Date:	Signature:
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DOCUMENT APPROVAL

Name	Function
Menniti, Pietro	Division Marketing Manager
Borghi, Maria Rosa	Division Product Manager
Motta, Antonino	Division Q.A. Manager



**L6726A/TR, L6727/TR & L6783A/TR Devices in SO8 package
2nd source of Assembly and Testing plant in Bouskoura 2000 plant**

WHAT:

- Following the Corporate decision to move the SOIC Narrow packages to Bouskoura 2000 plant (Marocco), we are going to move also the following devices in SO8 package:
 - L6726A (UM06 line)
 - L6726ATR “
 - L6727 (UM07 line)
 - L6727TR “
 - L6783A (UM07 line)
 - L6783ATR “

WHY:

Corporate package roadmap & capacity increase

HOW:

SOIC Narrow production line is already qualified and running in production in Bouskoura. However for these device, the line UM07 has been chosen as test vehicle and the relevant qualification report will be available in wk 48, 2007 and provided upon customer's request.

WHEN:

The production of the new devices could start by Q4, 2007. The relevant samples could be available starting from end November 2007.

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